Title: WIRE BOND-LESS ELECTRONIC COMPONENT FOR USE WITH AN EXTERNAL

CIRCUIT AND METHOD OF MANUFACTURE

Serial No.: Unknown

**Information Disclosure Statement** 

No representation is made that a search has been performed. No admission is made that the information cited in this statement is, or is considered to be, material to the patentability of the subject patent application.

Respectfully submitted,

Dated: 04 January 2012 By George C. Chen, Reg. No. 39,935

Bryan Cave, LLP

Two North Central Avenue, Suite 2200

Phoenix, Arizona 85004-4406

Telephone: (602) 364-7000

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